

ME2159A



0.8A Step-Up Current Mode PWM Converter ME2159A

Description

The ME2159A is a current mode boost DC-DC converter. Its PWM circuitry with built-in 0.18Ω power MOSFET make this regulator highly power efficient. The internal compensation network also minimizes as much as 6 external component counts. The non-inverting input of error amplifier connects to a 0.6V precision reference voltage and internal soft-start function can reduce the inrush current.

Features

- Precision Feedback Reference Voltage:
 0.6V Reference Voltage accuracy: ±2%
- Adjustable Output up to 12V
- Internal Fixed PWM frequency: 650KHz
- Internal 0.18Ω,2A, 16V Power MOSFET
- Shutdown Current: 0.1µA
- Over Temperature Protection:165 ℃

Applications

- Chargers
- LCD Displays
- Digital Cameras
- Handheld Devices
- Portable Products

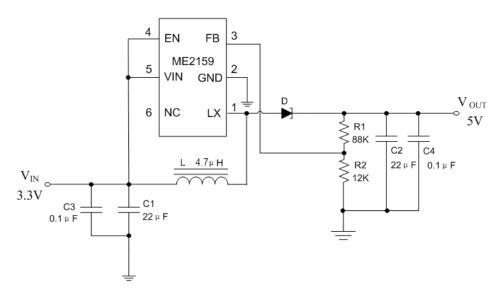
Package

• 6-pin SOT23-6

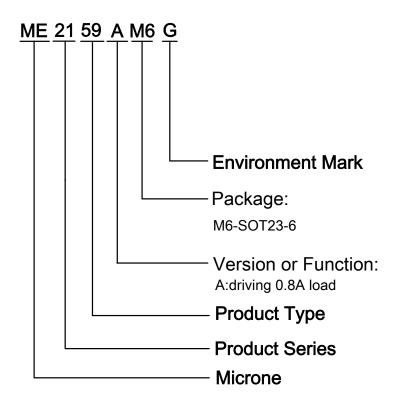
V05 Page 1 of 9



Typical Application



Selection Guide

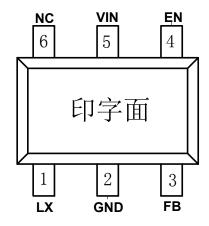


product series	product function	Output voltage	Package
ME2159AM6G	ME2159AM6G Driving 0.8A Load		SOT23-6

V05 Page 2 of 9



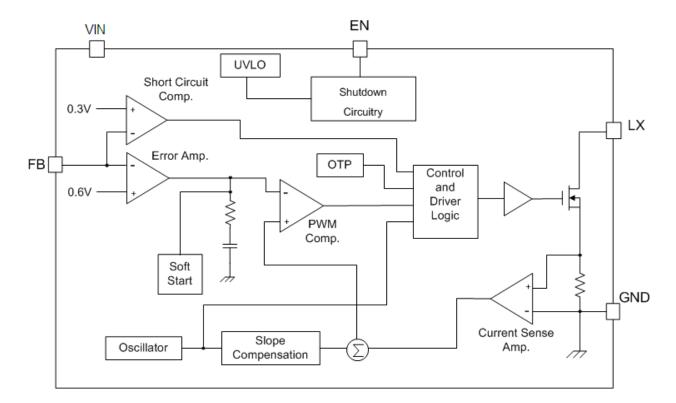
Pin Configuration



Pin information

Pin Number	Name	Function		
1	LX	Power Switch Output		
2	GND	Ground		
3	FB	Feedback		
4	EN	Chip Enable(Active High)		
5	VIN	Power Supply		
6	NC	NC		

Block Diagram



V05 Page 3 of 9



Absolute Maximum Ratings

Parameter	Symbal	Rating	Unit
Power supply voltage, V _{IN}	V _{IN}	-0.3∼6.0	V
voltage at EN、FB Pin	V_{EN}, V_{FB}	-0.3∼V _{IN}	V
voltage at SW Pin	V_{LX}	-0.3~12	V
LX Pin Current	I _{LX}	1850 (VIN=3.0V,VOUT=5.0V)	mA
Internal Power Dissipation (SOT23-6)	P_{D}	300	mW
Operating Ambient Temperature	T_{opr}	-40~125	°C
Storage Temperature	T _{stg}	-40~+150	°C
Soldering temperature and time	T _{solder}	260°C, 10S	°C

Electrical Characteristics

 $(V_{IN} = V_{EN} = 3.3V, \ V_{OUT} = 5V, \ C1 = C2 = 22 \mu F, \ L = 4.7 \mu H, \ T_A = 25 \ ^{\circ}C, \ unless \ otherwise \ noted.)$

Parameter	Symbol	Test condition	Min	Тур.	Max	Unit	
System Supply Input							
Input voltage range	V _{IN}		2.5	-	5.5	V	
Under Voltage Lockout	V _{UVLO}			2.15		V	
UVLO Hysteresis				0.08		V	
Average Supply Current	I _{SS1}	V _{FB} =0.55V, Switching		0.8	1.5	mA	
Quiescent Current	I _{SS2}	V _{FB} =0.66V, No Switching		280	360	μA	
Shutdown Supply Current	I _{SS3}	V _{EN} =GND		0.1	5	μA	
Oscillator	Oscillator						
Operation Frequency	Fosc	V _{FB} =1.0V	0.5	0.65	0.8	MHz	
Maximum Duty Cycle	D _{MAX}			90		%	
Minimum Duty Cycle	D _{MIN}			22		%	
Reference Voltage							
Reference Voltage	V _{FB}		0.588	0.6	0.612	V	
Line Regulation		V _{IN} =2.6V to 4.3V		0.03	0.1	%/V	

V05 Page 4 of 9



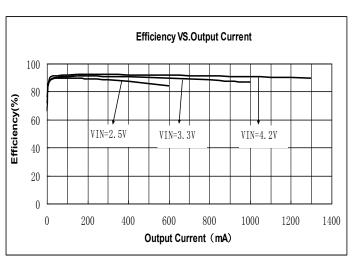
Enable Control						
Enable Voltage	V _{EN}		1.5			V
Shutdown Voltage	V _{EN}		-		0.6	٧
MOSFET	MOSFET					
On Resistance of Driver	R _{DS (ON)}	I _{LX} =2A		0.18		Ω
Protection						
OCP Current	I _{OCP}			1.85		Α
Over Temperature Protection	OTP		-	165	-	°C
OTP Hysteresis	ОТН		-	25	-	°C

Typical Performance Characteristics (ME2159AM6G)

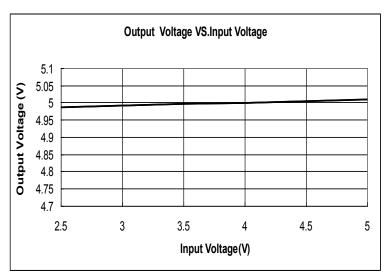
1. Output Voltage VS. Output Current (Vout =5.0V)

Output Voltage VS.Output Current 5.1 5.05 4.95 4.9 4.85 VIN=2.5V VDE3.3V 4.8 4.75 4.7 400 600 800 1000 0 200 1200 1400 Output Current (mA)

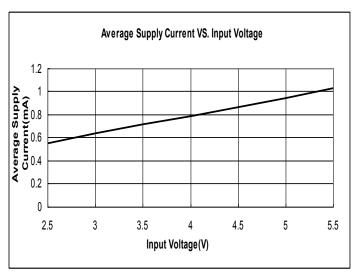
2、Efficiency VS. Output Current(Vout=5.0V)



3、 V_{OUT} VS. Input Voltage (I_{OUT} =10mA)



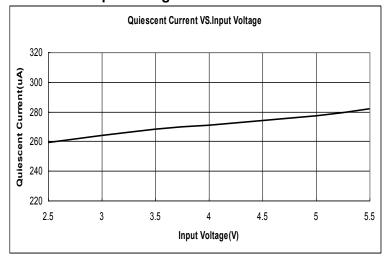
4、I_{SS1} VS. Input Voltage



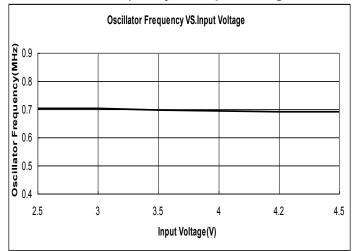
V05 Page 5 of 9



5、ISS2 VS. Input Voltage



6. Oscillator Frequency VS. Input Voltage



Function Description

Operation

The ME2159A is a current mode boost converter. The constant switching frequency is 1MHz and operates with pulse width modulation (PWM). Build-in 16V / 2A MOSFET provides a high output voltage. The control loop architecture

is peak current mode control; therefore slope compensation circuit is added to the current signal to allow stable operation for duty cycles larger than 50%.

Soft Start Function

Soft start circuitry is integrated into ME2159A to avoid inrush current during power on. After the IC is enabled, the output of error amplifier is clamped by the internal soft-start function, which causes PWM pulse width increasing slowly and thus reducing input surge current.

Over Temperature Protection (OTP)

The ME2159A will turn off the power MOSFET automatically when the internal junction temperature is over 150° C. The power MOSFET wake up when the junction temperature drops 30° C under the OTP threshold temperature.

Output Disconnect

When power on and the EN pin will be pulled high. The ME2159A start up and operates. The external PMOS is turned on and current through it for output loading. While output loading is increase, output voltage is drop. When the FB pin voltage is under 0.3V, the EN pin sinks 20µA current, the external PMOS will be turn off. The output short condition will be disconnected.

V05 Page 6 of 9



Application Information

Inductor Selection

Inductance value is decided based on different condition. 3.3uH to 4.7µH inductor value is recommended for general application circuit. There are three important inductor specifications, DC resistance, saturation current and core loss. Low DC resistance has better power efficiency. Also, it avoids inductor saturation which will cause circuit system unstable and lower core loss at 1MHz.

Capacitor Selection

The output capacitor is required to maintain the DC voltage. Low ESR capacitors are preferred to reduce the output voltage ripple. Ceramic capacitor of X5R and X7R are recommended, which have low equivalent series resistance (ESR) and wider operation temperature range.

Diode Selection

Schottky diodes with fast recovery times and low forward voltages are recommended. Ensure the diode average and peak current rating exceed the average output current and peak inductor current. In addition, the diode's reverse breakdown voltage must exceed the output voltage.

Output Voltage Programming

The output voltage is set by a resistive voltage divider from the output voltage to FB. The output voltage is:

$$V_{OUT} = 0.6 \times \left(1 + \frac{R_1}{R_2}\right)$$

PCB Layout Check List

When laying out the printed circuit board, the following checklist should be used to ensure proper operation of the ME2159A.

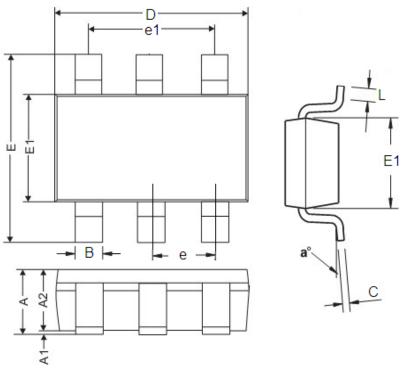
- 1. The power traces, consisting of the GND trace, the SW trace and the V_{IN} trace should be kept short, direct and wide.
- 2. LX、L and D switching node, wide and short trace to reduce EMI.
- 3. Place CIN near VCC pin as closely as possible to maintain input voltage steady and filter out the pulsing input current.
- 4. The resistive divider R1and R2 must be connected to FB pin directly as closely as possible. the internal power MOSFETs.
- 5. FB is a sensitive node. Please keep it away from switching node, LX.
- 6. The GND of the IC, CIN and COUT should be connected close together directly to a ground plane.

V05 Page 7 of 9



Package Information

● Package type:SOT23-6



DIM	Millin	neters	Inches		
	Min	Max	Min	Max	
Α	0.9	1.45	0.0354	0.0570	
A1	0	0.15	0	0.0059	
A2	0.9	1.3	0.0354	0.0511	
В	0.2	0.5	0.0078	0.0196	
С	0.09	0.26	0.0035	0.0102	
D	2.7	3.10	0.1062	0.1220	
E	2.2	3.2	0.0866	0.1181	
E1	1.30	1.80	0.0511	0.0708	
е	0.95REF		0.0374REF		
e1	1.90REF		0.0748REF		
L	0.10	0.60	0.0039	0.0236	
a ⁰	00	30°	O°	30°	

V05 Page 8 of 9



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V05 Page 9 of 9